

Sponsorship Opportunities at the PACRIM 11 in Korea

Make your company visible to the world community of
ceramic and non-ceramic



The 11th Pacific Rim Conference of Ceramic Societies

PACRIM 11

August 30 ~ September 4, 2015

International Convention Center JEJU (ICC JEJU), Jeju, Korea

Information for Sponsorship

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1. Greetings

Welcome to the 11th International Conference of Pacific Rim Ceramic Societies (PacRim-11) in the beautiful Jeju Island in Korea from Aug. 30th to Sept. 4th, 2015. This conference is the eleventh in the series of international conferences that provides a global forum for presentations and information exchange on the latest emerging ceramic technologies. This conference series began in 1993, hosted by the American Ceramic Society in Hawaii. Since then, PacRim conferences have been held in various countries including Australia, Korea, Japan, China and Canada. Over the years, PacRim conferences have established a strong reputation for the state-of-the-art presentation and information exchange on the cutting edge ceramic technologies. They have facilitated global dialogue and discussion with leading global experts. We would like to invite all of you to take advantage of this unique opportunity to visit beautiful Jeju Island and actively participate in this conference. We hope to provide an excellent forum for interaction and developing friendships with participants from various countries from various continents, who are involved in research, development, engineering, manufacturing and application of ceramic materials.

Jeju Island is located off the south coast of Korea, world-class resort area with easy access. It has mild subtropical climate, visa-free entry for 180 countries, and designated as UNESCO World Nature Heritage. The conference place is International Convention Center Jeju(ICC jeju), equipped with modern facilities and commands a gorgeous view of the Pacific Ocean.

I am looking forward to seeing all of you in Jeju Island.

Hai - Doo Kim

Dr. Hai-Doo Kim

Chairman, PACRIM 11

Korean Institute of Materials Science (KIMS)

2. Introduction of PACRIM 11

◆ Conference Title: **The 11th Pacific Rim Conference of Ceramic Societies (PACRIM 11)**

◆ Conference Date: **August 30 ~ September 4, 2015**

◆ Venue: **ICC Jeju, Jeju, Korea**

◆ Organized by  **The Korean Ceramic Society**

◆ Supported by



◆ Expected Number of Participants: **More than 1,500 persons from 30 countries**

◆ **Organizing Committee**

Chairman		Hai-Doo Kim	Korean Institute of Materials Science (KIMS)
Secretary General		DoKyung Kim	Korea Advanced Institute of Science and Technology (KAIST)
Technical Program Committee	Chair	Young-Wook Kim	University of Seoul
	Co-Chair	Hae jin Hwang	Inha University
Finance/Sponsor Committee	Chair	Yong Soo Cho	Yonsei University
Publicity/Marketing Committee	Chair	Kee Sung Lee	Kookmin University
Exhibition/Local Arrangement Committee	Chair	Beyong Hwan Ryu	Korea Research Institute of Chemical Technology (KRICT)
	Co-Chair	Won-seon Seo	Korea Institute of Ceramic Engineering and Technology (KICET)



3. Tentative Schedule

Time	Aug. 30 (Sun.)	Aug. 31 (Mon.)		Sep. 1 (Tue.)		Sep. 2 (Wed.)		Sep. 3 (Thu.)		Sep. 4 (Fri.)		
Morning		Opening & Plenary	Exhibition	Tech. Sessions	Exhibition	Tech. Sessions	Exhibition	Tech. Sessions	Exhibition	Tech. Sessions	Exhibition	
Lunch		Lunch		Lunch		Lunch		Lunch		Lunch	Lunch	Optional Tour
Afternoon		Tech. Sessions		Tech. Sessions		Tech. Sessions		Tech. Sessions		Tech. Sessions		
Dinner	Welcome Reception			Poster Session		Poster Session		Poster Session		Conference Dinner		

4. Information for Sponsorship

◆ Sponsorship Benefits

Please confirm to the following benefits as below.

1. TYPE A

LEVEL	BENEFITS	VALUE
Diamond	<ul style="list-style-type: none"> - Three (3) complementary regular registrations - Acknowledgement in the program book - Advertisement of the company in the program book - Logo and web link on the conference website - Logo featured on newsletter mailed to associates - Logo featured on screen in the general session - Logo featured on the banner 	Over \$10,000
Platinum	<ul style="list-style-type: none"> - One (1) complementary regular registrations - Acknowledgement in the program book - Advertisement of the company in the program book - Logo and web link on the conference website - Logo featured on newsletter mailed to associates - Logo featured on screen in the general session - Logo featured on the banner 	\$7,000
Gold	<ul style="list-style-type: none"> - Acknowledgement in the program book - Advertisement of the company in the program book - Logo and web link on the conference website - Logo featured on newsletter mailed to associates - Logo featured on screen in the general session - Logo featured on the banner 	\$5,000
Bronze	<ul style="list-style-type: none"> - Acknowledgement in the program book - Logo and web link on the conference website - Logo featured on newsletter mailed to associates - Logo featured on screen in the general session - Logo featured on the banner 	\$ 2,000
Total		\$ _____

2. TYPE B

LEVEL	BENEFITS	VALUE
Conference Dinner	<ul style="list-style-type: none"> - Congratulatory talk at the Banquet - Acknowledgement in the program book - Advertisement of the company in the program book - Logo and web link on the conference website - Logo featured on newsletter mailed to associates - Logo featured on screen in the general session - Logo featured on the banner - Put the company logo on the placard at the banquet 	Please contact a secretariat
Welcome Reception	<ul style="list-style-type: none"> - Acknowledgement in the program book - Advertisement of the company in the program book - Logo and web link on the conference website - Logo featured on newsletter mailed to associates - Logo featured on screen in the general session - Logo featured on the banner - Put the company logo on the placard at the reception 	
Souvenir	<ul style="list-style-type: none"> - Acknowledgement in the program book - Advertisement of the company in the program book - Logo and web link on the conference website - Logo featured on newsletter mailed to associates - Logo featured on screen in the general session - Logo featured on the souvenir 	
Coffee Break	<ul style="list-style-type: none"> - Acknowledgement in the program book - Advertisement of the company in the program book - Logo and web link on the conference website - Logo featured on newsletter mailed to associates - Logo featured on screen in the general session - Logo featured on the table during coffee break 	
Total		\$ _____

3. TYPE C = Advertisement in Program Book

PLACE	VALUE
Outside Back Cover (by order of arrival)	\$10,000
Inside Back Cover (by order of arrival)	\$5,000
Inside Cover (by order of arrival)	\$5,000
The First Inside Cover Page (by order of arrival)	\$4,000
The Inside Back (by order of arrival)	\$4,000
Colored Full-Page	\$2,000
Colored Half Page	\$1,200
Total	\$ _____

4. Contact Point

PACRIM 11 Secretariat

Ms. A-Young Kim / Ms. Kelly Kim

Address: 2F, 927 Tamnip-dong, Yuseong-gu, Daejeon, Korea 305-510

Tel: +82-42-472-7460

Fax: +82-42-472-7459

E-mail: pacrim11@pacrim11.org

Web-site: <http://www.pacrim11.org>



Sponsorship Application Form

Please fill out the below application form, and send it back to the secretariat

■ PACRIM 11 Secretariat (Ms. A-Young Kim / Ms. Kelly Kim)
 Tel: +82-42-472-7461/ Fax: +82-42-472-7459 /E-mail: pacrim11@pacrim11.org

◆ Information of the Company

■ Company Name			
■ President		■ Person in Charge	
■ Department			
■ Address			
■ Zip Code		■ Country	
■ Tel		■ Fax	
■ E-mail			

◆ Sponsorship

- Please fill out the below table.

[TYPE]	Amount	Request

* Please fill a type & amount of sponsorship in on the sheet.

◆ Payment Method

- Bank Transfer
- Account Information
- Please complete the wire transfer to the below account:

- **Account Holders:** The Korean Ceramic Society
- **Account No.:** 1005-302-383204
- **Bank Name:** WOORI BANK PANGBAEYOK BRANCH
- **Address of Bank:** 76 Bangbae-ro, Seocho-gu, Seoul, Korea
- **Swift Code:** HVBKCRSEXXX

Date: _____

Signature: _____